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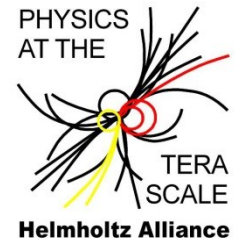
# Measurement of the drift velocities of electrons and holes in high-ohmic <100> silicon

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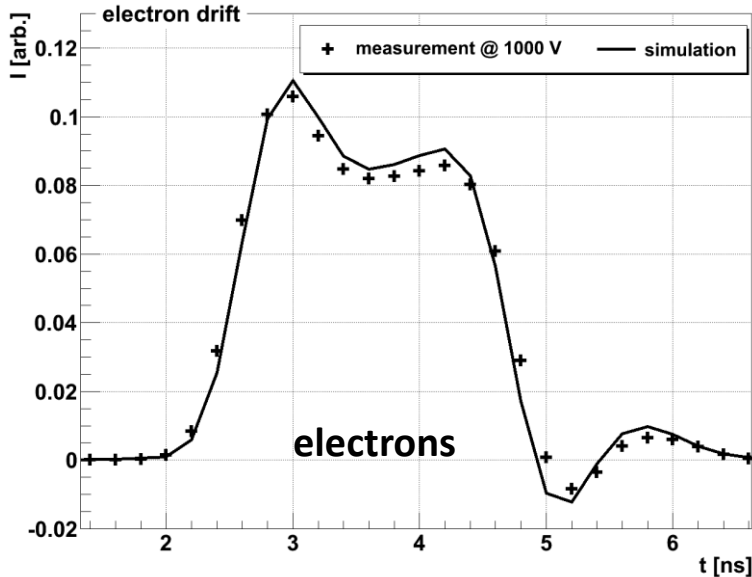
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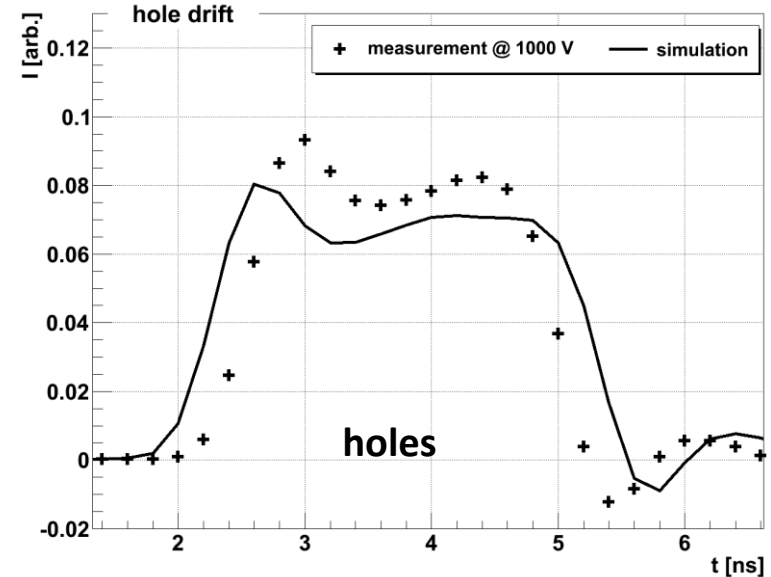


# 1 – Motivation

# Motivation



200  $\mu\text{m}$   
 <100> sensor  
  
 drift model:  
 Jacoboni 1977  
 <111>  
 ↓  
 often used for  
 <100>



**The <100> drift velocity is a fundamental material parameter!**

**BUT:** The literature mobility models for <100> and <111> direction do not describe measurements of non irradiated sensors

**Precise knowledge of the drift velocities of electrons and holes is needed for precise simulations and the analysis of (edge-)TCT**



## 2 – Experimental method

# Diodes and measurements

- Diodes:** High-ohmic <100> float-zone silicon  $p^+nn^+$  and  $n^+pp^+$  pad diodes

Three different sensors investigated:

Standard sensor →

Used for cross check {

Vendor	Bulk	w [ $\mu\text{m}$ ]	$U_{\text{dep}}$ [V]	$N_{\text{eff}}$ [ $\text{cm}^{-3}$ ]	$\rho$ [ $\text{k}\Omega\text{cm}$ ]
HPK	N-type	$200 \pm 2$	90	$2.9 \cdot 10^{12}$	1.5
HPK	P-type	$200 \pm 2$	115	$3.8 \cdot 10^{12}$	1.1
CiS	N-type	$287 \pm 3$	50	$0.8 \cdot 10^{12}$	5.5

# Diodes and measurements

- Diodes:** High-ohmic <100> float-zone silicon p<sup>+</sup>nn<sup>+</sup> and n<sup>+</sup>pp<sup>+</sup> pad diodes

Three different sensors investigated:

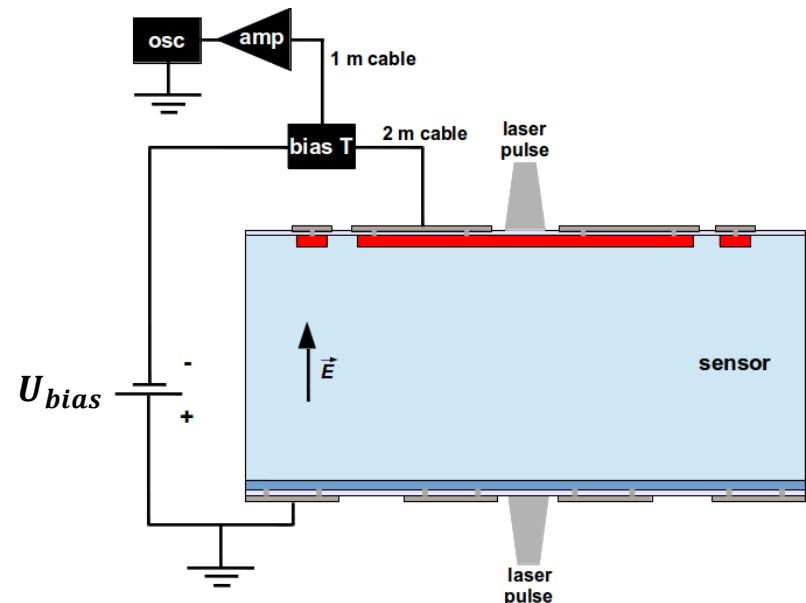
	Vendor	Bulk	w [μm]	U <sub>dep</sub> [V]	N <sub>eff</sub> [cm <sup>-3</sup> ]	ρ [kΩcm]
Standard sensor →	HPK	N-type	200±2	90	2.9·10 <sup>12</sup>	1.5
Used for cross check {	HPK	P-type	200±2	115	3.8·10 <sup>12</sup>	1.1
	CiS	N-type	287±3	50	0.8·10 <sup>12</sup>	5.5

## Transient current technique TCT

- Pulsed laser generates e-h pairs in the sensor
- Charge carriers drift in electric field  
→ induced signal  $I \propto v_d(E(x))$

### Measurements

- $U_{dep} < U_{bias} \leq 1000$  V steps of  $\Delta U_{bias} = 10$  V
- Seven temperatures between **233 K** and **333 K**



# Transient Current Technique

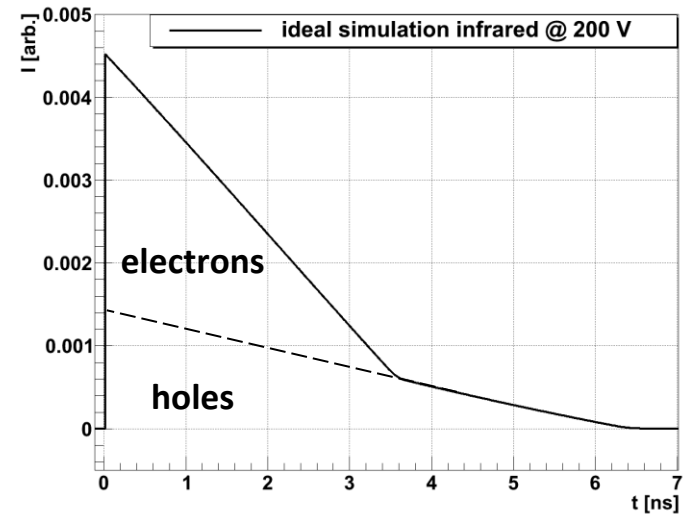
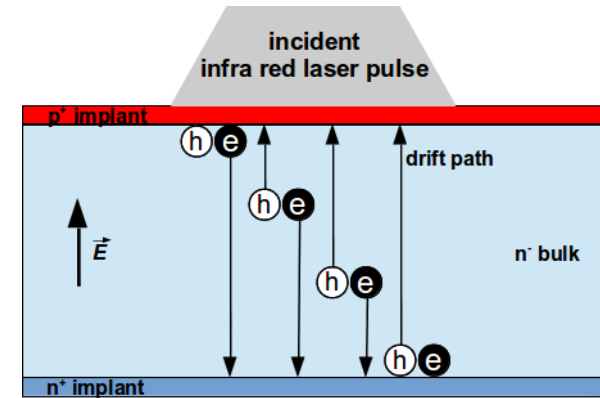
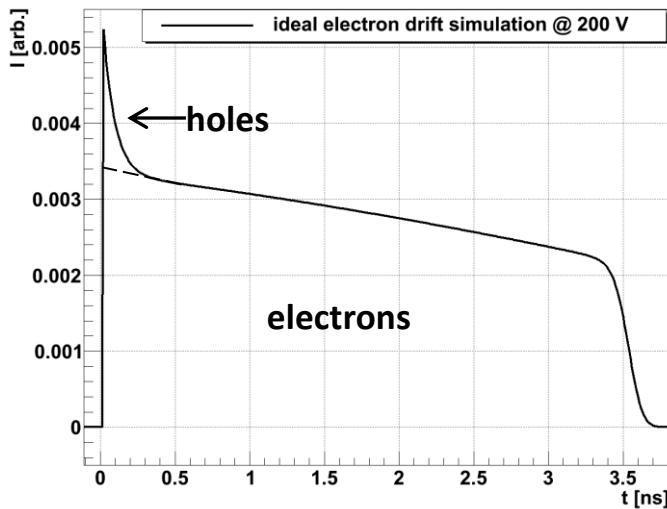
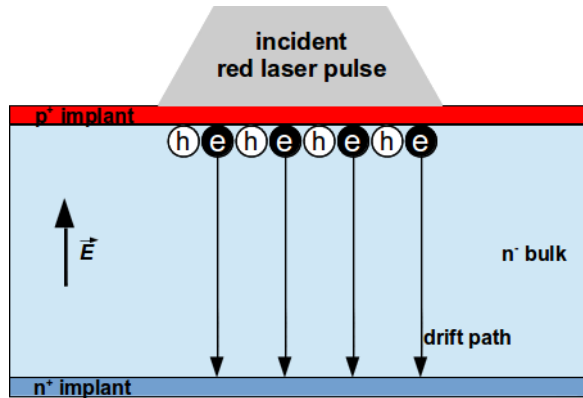
- **Red laser**  $\lambda = 675 \text{ nm}$   
 → signal induced by drift of e or h

- **Infrared laser**  $\lambda = 1063 \text{ nm}$   
 → simultaneous e and h drift

$FWHM \approx 50 \text{ ps}$

initial charge distribution

simulation  
 200  $\mu\text{m}$  sensor  
 @ 200 V





# 3 – Analysis methods



# Transient current simulation

- **Fit of the mobility parameters for red + infrared measurements at all bias voltages + temperatures at once** → up to 622 measurements

- **Grid**

$$\delta x = 100 \text{ nm}$$

- **Charge transport** with  $\Delta t = 10 \text{ ps}$

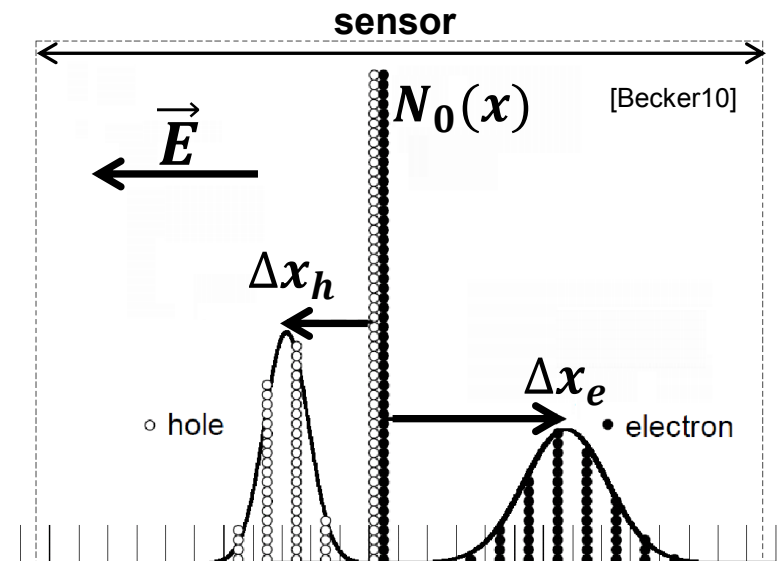
→ **Drift**

$$\Delta x_{e,h} = v_{e,h}(x) \cdot \Delta t = \mu_{e,h}(x) E(x) \cdot \Delta t$$

→ **Diffusion** → Gaussian function

$$\sigma_{e,h}(x) = \sqrt{2D_{e,h}(x) \cdot \Delta t}$$

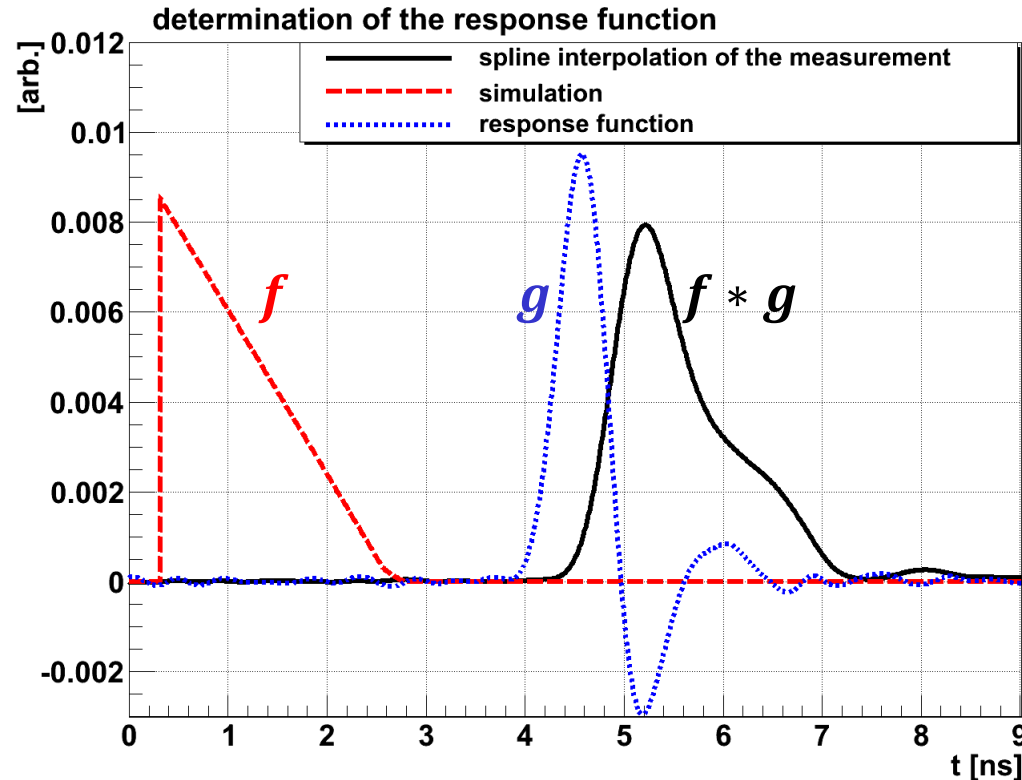
$$D_{e,h}(x) = \frac{\mu_{e,h}(x) k_b T}{e_0}$$



# Transient current simulation: Transfer function

Convolution theorem:

$$\mathcal{F}\{f * g\} = \mathcal{F}\{f\} \cdot \mathcal{F}\{g\}$$

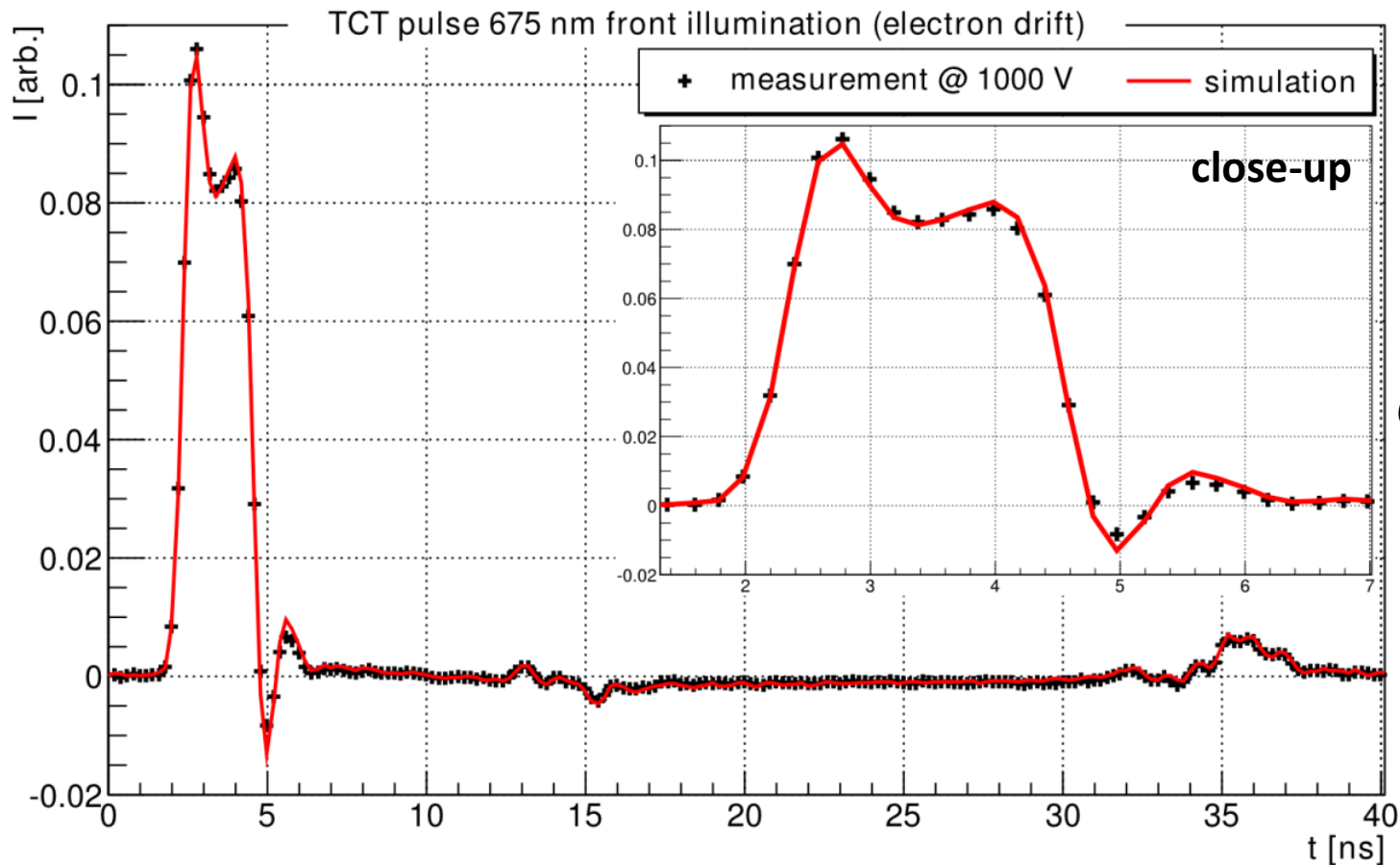


infrared laser  
 200  $\mu\text{m}$  sensor  
 @ 1000 V and 313 K

Transfer function of  
the read-out circuit

$$\rightarrow g = \mathcal{F}^{-1} \left\{ \frac{\mathcal{F}\{measurement\}}{\mathcal{F}\{simulation\}} \right\}$$

# Transient current simulation: Transfer function



red laser (e drift)  
 200  $\mu\text{m}$  sensor  
 @ 1000 V and 313 K

with  $g$  for the  
 infrared laser

- For all simulations  $g$  for the infrared laser @ 1000 V and 313 K was used  
 → fast signal, e and h contribution

# The time-of-flight method

- Carrier time of flight  $tof$   
→ points of maximum slope
- Signal sampling 200 ps → spline interpolation

Problem:  $E(x) \neq const$

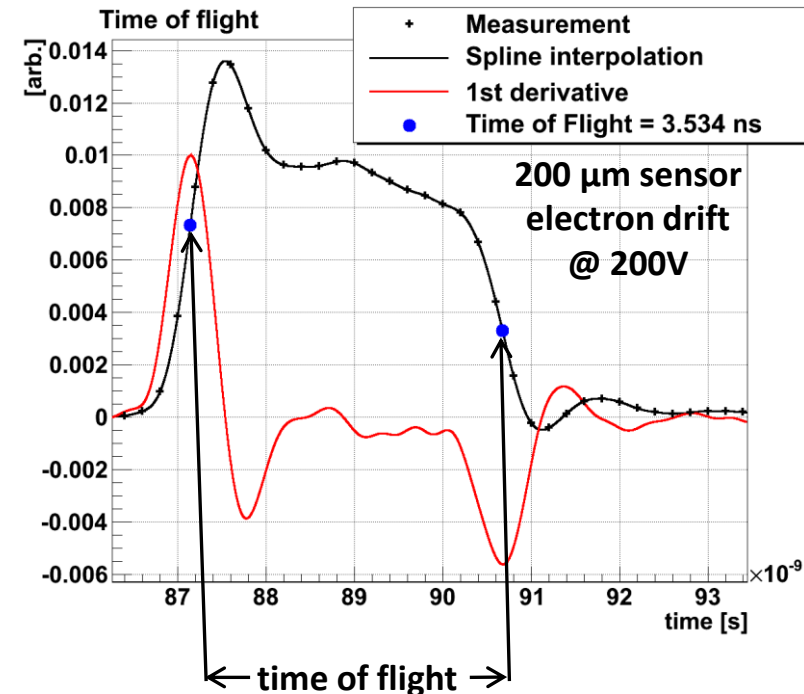
$$tof = \int_0^w \frac{dx}{v_d(E(x))}$$

→ Assume  $\frac{1}{v_d(E(x))} \propto \frac{1}{E(x)} + const$

→  $tof \propto w \cdot (\langle 1/E(x) \rangle + const)$

→  $v_d \left( \langle 1/E(x) \rangle^{-1} \right) = w/tof$

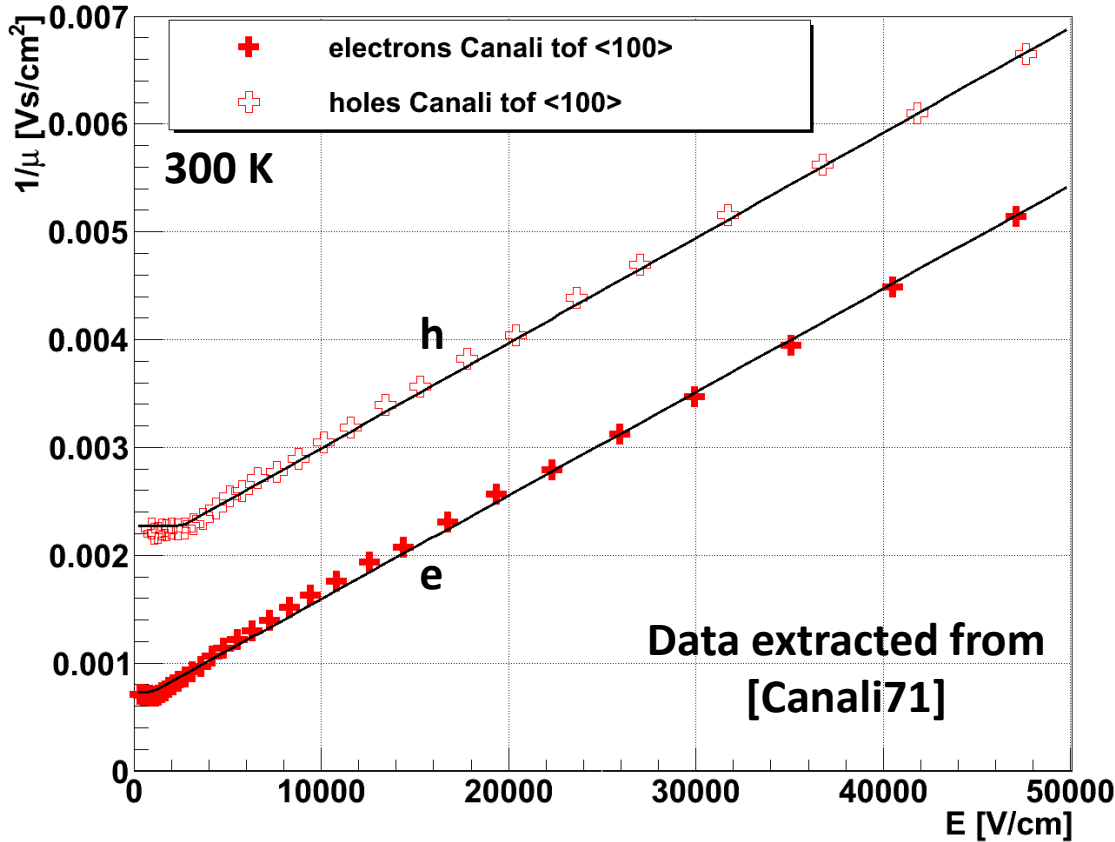
Red laser  
→ drift of one charge carrier type





# 4 – Results

# Mobility model



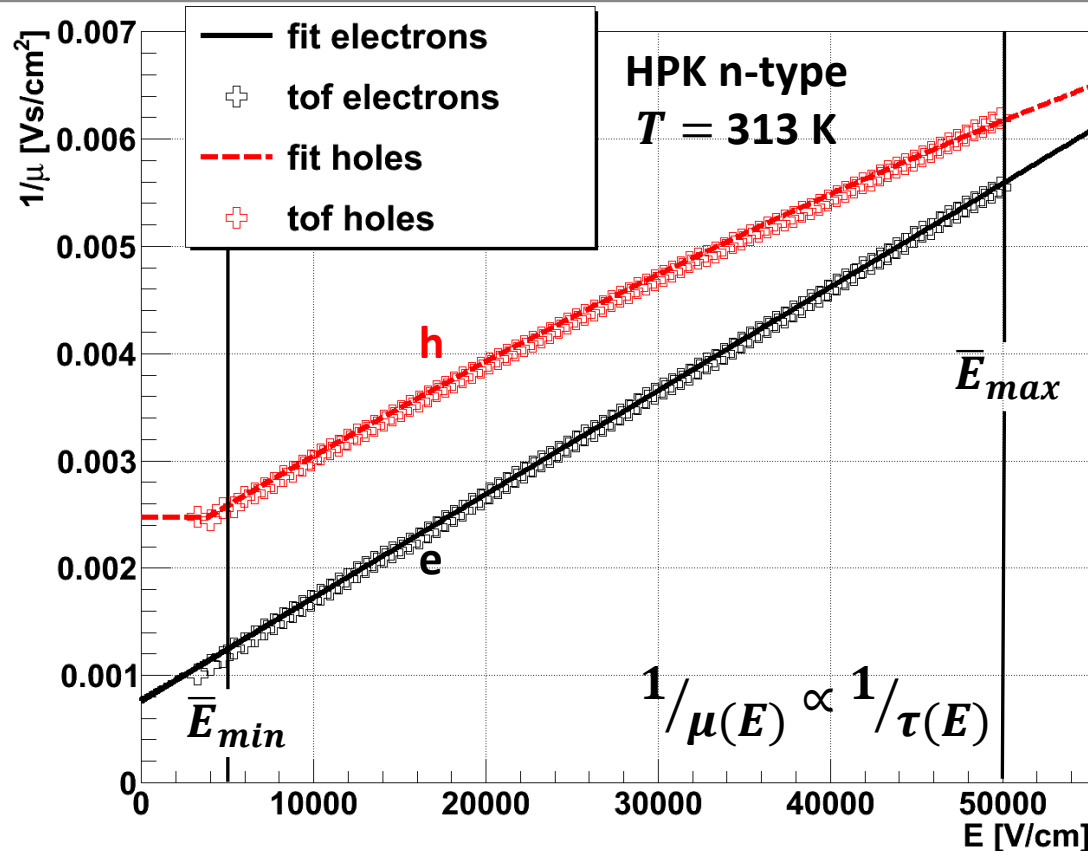
$$v_d(E) = \frac{qE}{2m^*} \tau(E) = \mu(E) \cdot E$$

$$\frac{1}{\mu(E)} \propto \frac{1}{\tau_{coll}} + \frac{1}{\tau_e(E)}$$

↑                      ↑  
 lattice              phonon  
 scattering          emission

$$\frac{1}{\mu(E)} = \begin{cases} \frac{1}{\mu_0} & , E < E_0 \\ \frac{1}{\mu_0} + \frac{1}{v_s} \cdot (E - E_0) & , E \geq E_0 \end{cases}$$

# Our results



$T$  dependence

$$par_i(T) = par_i^{RT} \cdot \left( \frac{T}{300 \text{ K}} \right)^{\alpha_i}$$

New parameterization fitted for

$$5 \text{ kV/cm} < \bar{E} < 50 \text{ kV/cm}$$

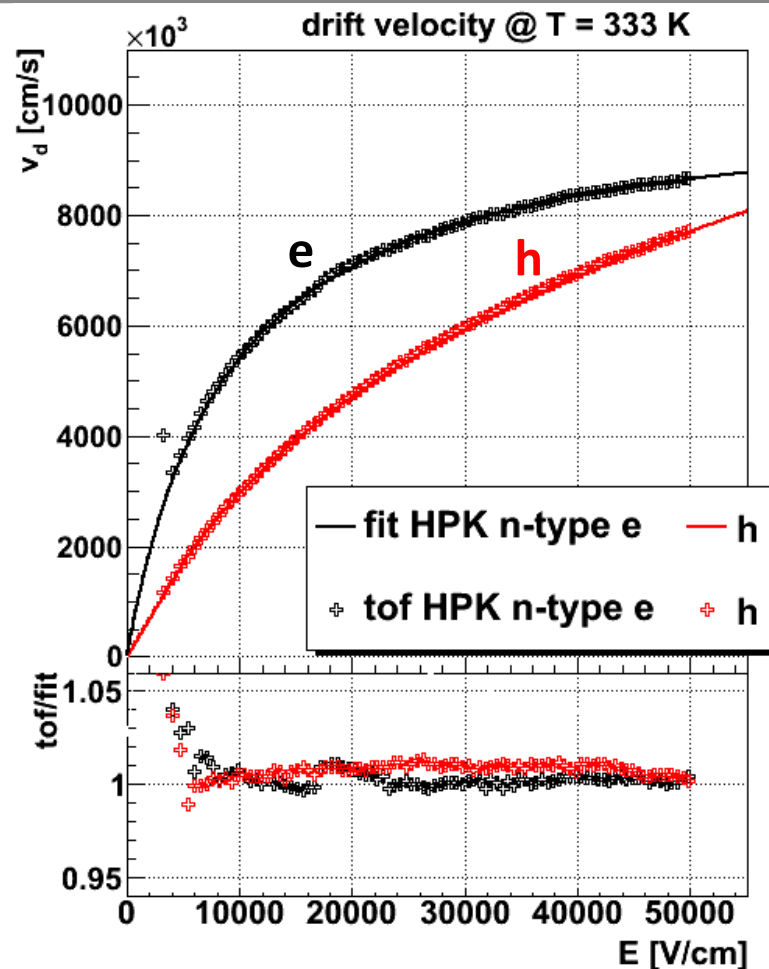
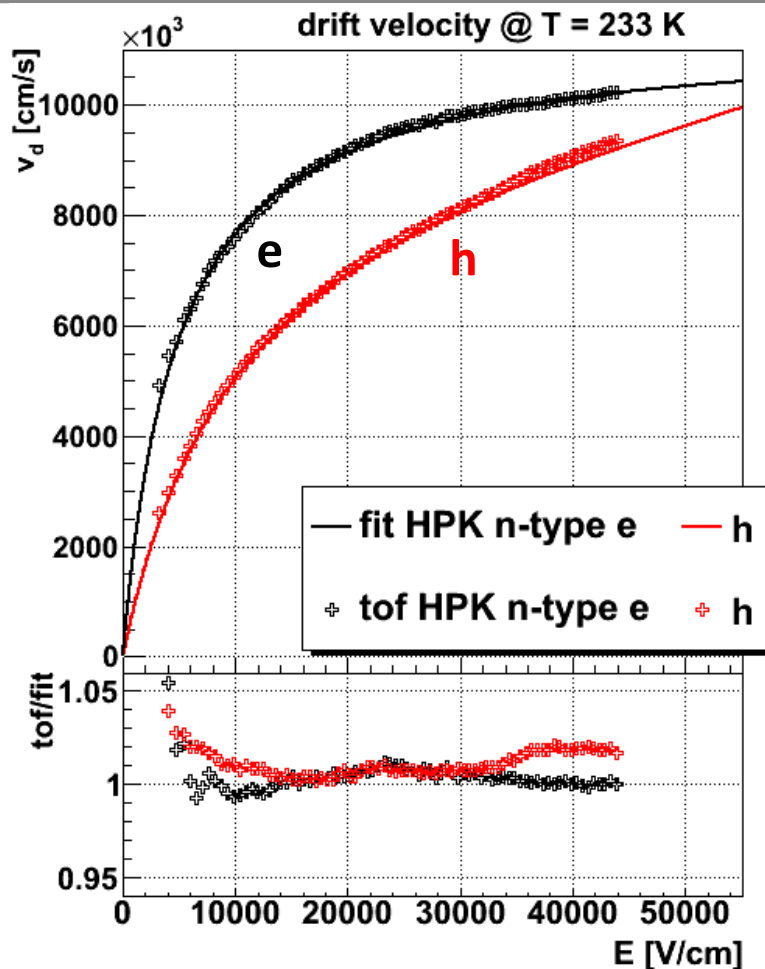
$$233 \text{ K} < T < 333 \text{ K}$$

→ Global fit with  $\sigma_{v_d} = \pm 2.5 \%$

- Electrons  $\frac{1}{\mu_e(E)} = \frac{1}{\mu_0^e} + \frac{1}{v_s^e} \cdot E$

- Holes  $\frac{1}{\mu_h(E)} = \max \left( \frac{1}{\mu_0^h}, \frac{1}{\mu_0^h} + b \cdot (E - E_0) + c \cdot (E - E_0)^2 \right)$

# Global fit results



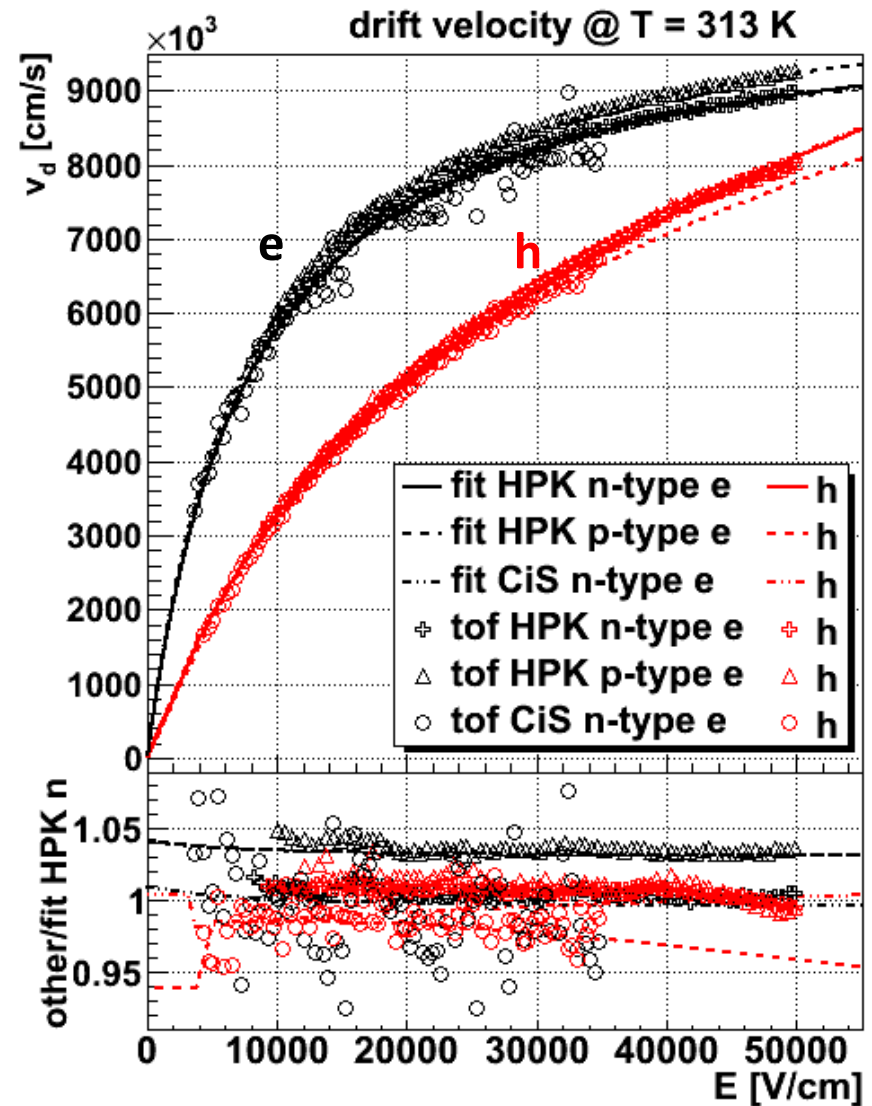
Max tof/fit deviation = 2 % for  $E > 7$  kV/cm



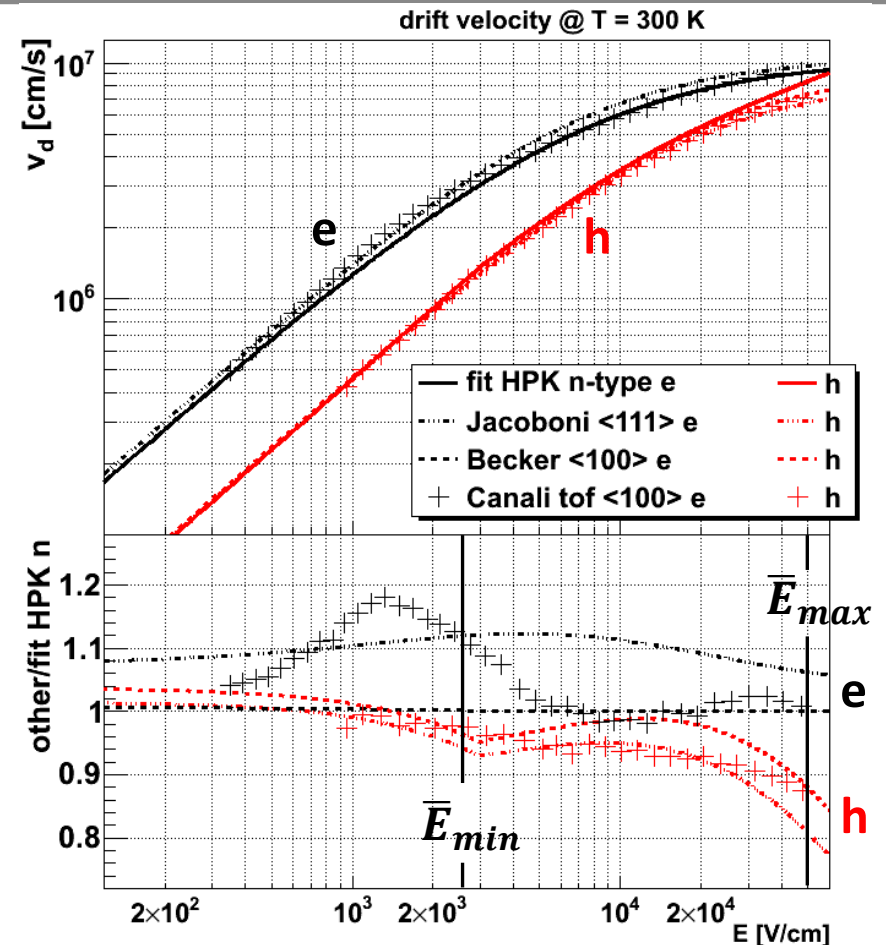
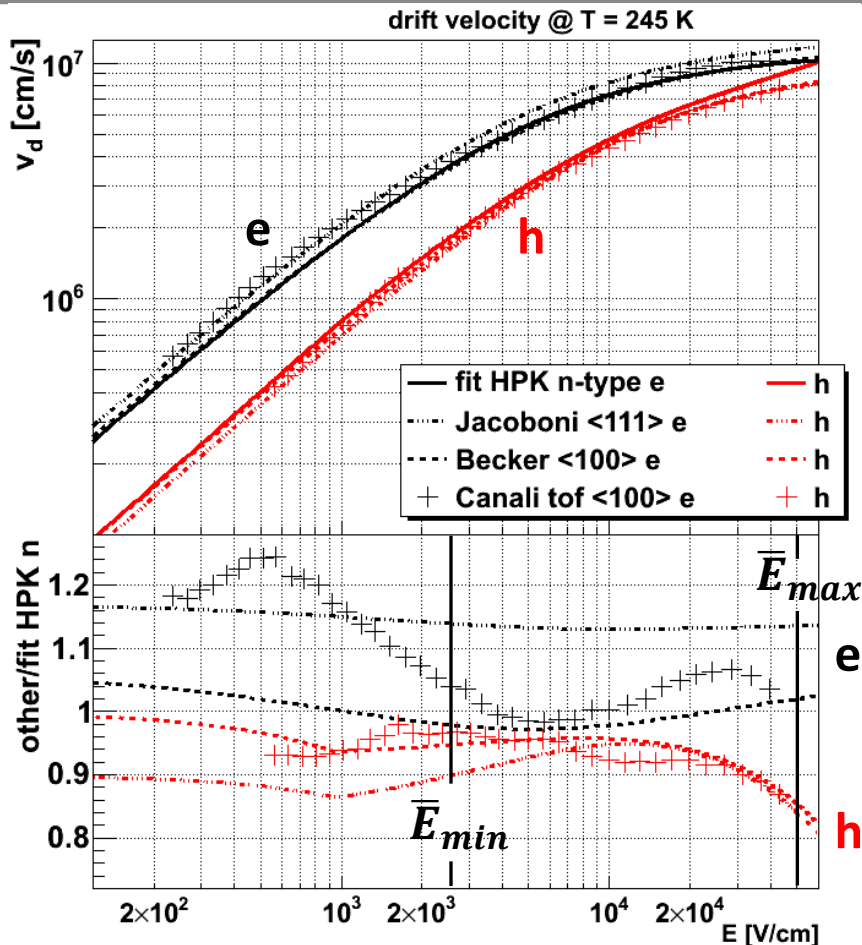
# Comparison of different materials

## Results of the different sensors @ T=313 K

- The results match within 4 %
- Each point corresponds to one individual measurement!



# Comparison with literature



Large differences observed:
 

- {
 Jacoboni <111>: for e and h
- Becker <100>: only for h @ high fields
- Canali <100>: for h @ high fields and e @ low fields



# 5 – Conclusion

# Conclusion

- **Analysis**
  - Time-of-flight method ←————— simple
    - High accuracy despite large field range in the sensor
  - Fit of drift simulation to TCT measurements ←—— complex
    - Precise determination of electronics response

- **Results**

- Parametrization of the mobility  $\mu(E, T)$  **max deviation**
- Results of **different sensors and of fit and tof are consistent** **4 %**
- Results similar to **<100>** literature values for **electron drift** **5 %**
- Large differences to **<100>** and **<111>** literature val. for **hole drift** **15 %**

- **Impact**

**The results will improve simulations and the analysis of  
 TCT and edge-TCT  $\rightarrow E(x), \tau_e(x), \tau_h(x)$**



# Thanks for your attention

## Special thanks to

**J. Becker, J. Erfle, E. Fretwurst , R. Klanner, T. Poehlsen, J. Schwandt**

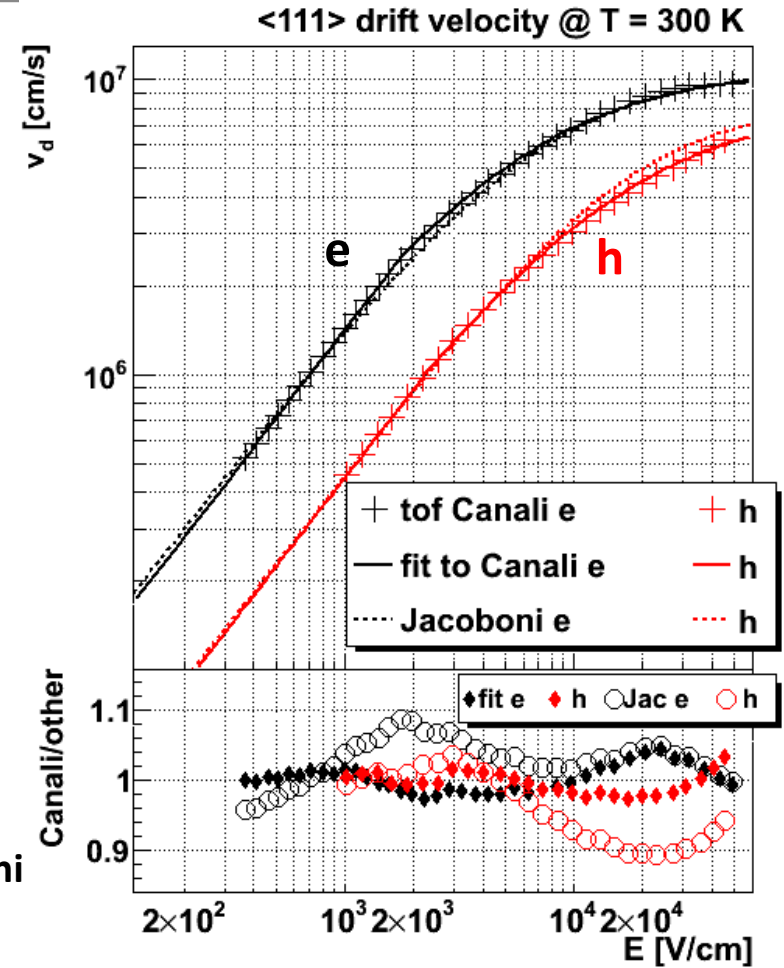
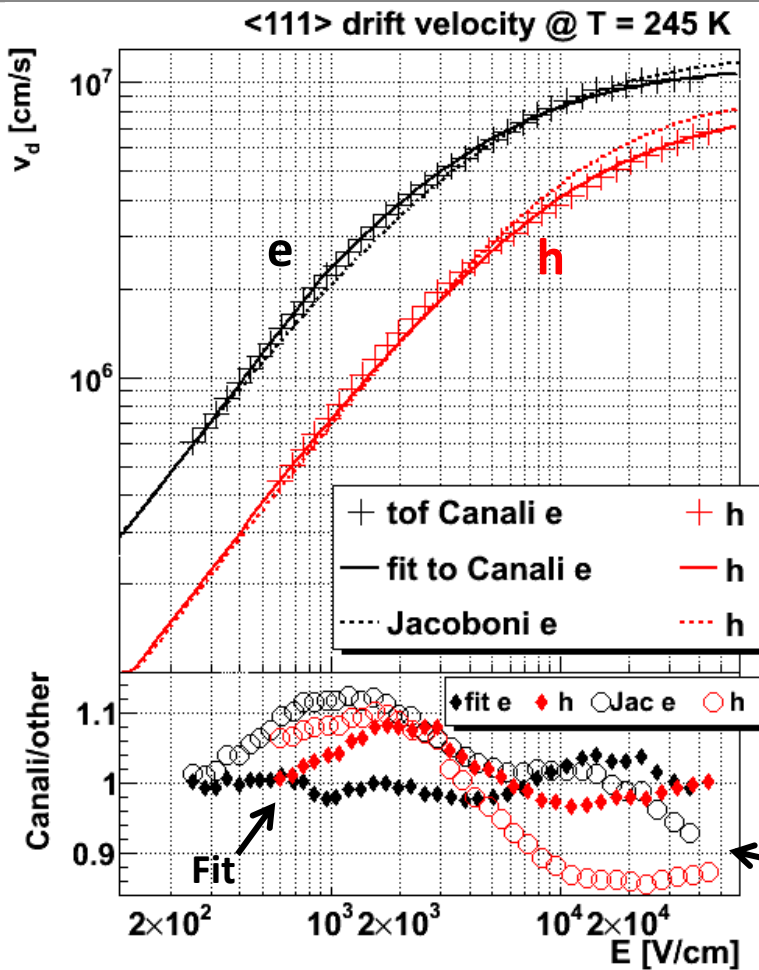
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- J Becker, E Fretwurst, and R Klanner. Measurements of charge carrier mobilities and drift velocity saturation in bulk silicon of  $\langle 111 \rangle$  and  $\langle 100 \rangle$  crystal orientation at high electric fields. *Solid-State Electronics*, 56(1):104110, 2011.
- C Canali, G Ottaviani, and A Alberigi Quaranta. Drift velocity of electrons and holes and associated anisotropic effects in silicon. *Journal of Physics and Chemistry of Solids*, 32(8):17071720, 1971.
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- C Jacoboni, C Canali, G Ottaviani, and A Alberigi Quaranta. A review of some charge transport properties of silicon. *Solid-State Electronics*, 20(2):77-89, 1977.



# Backup

# <111> literature mobility

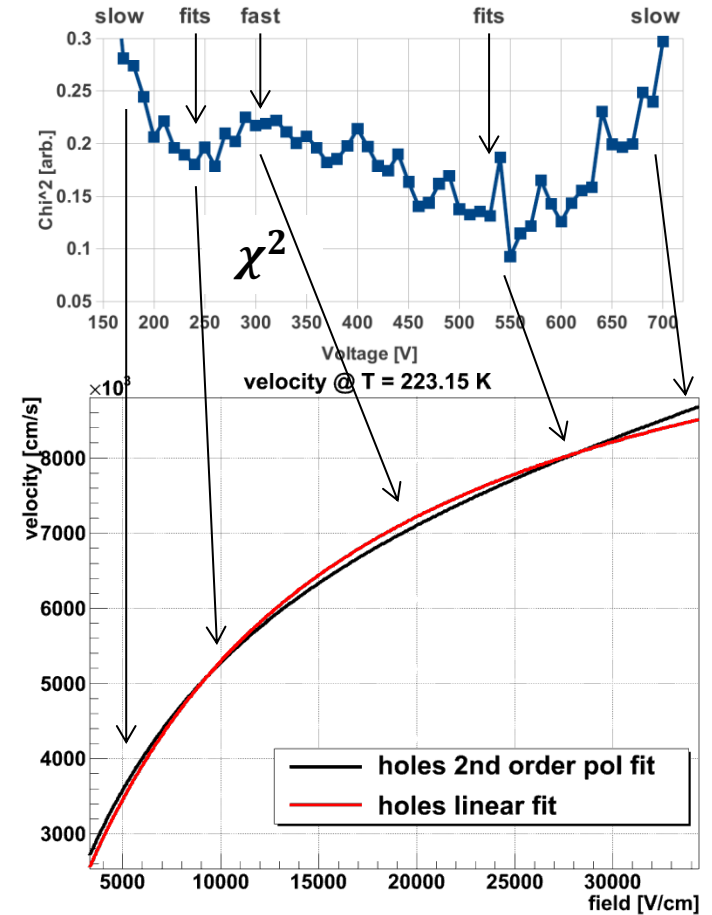
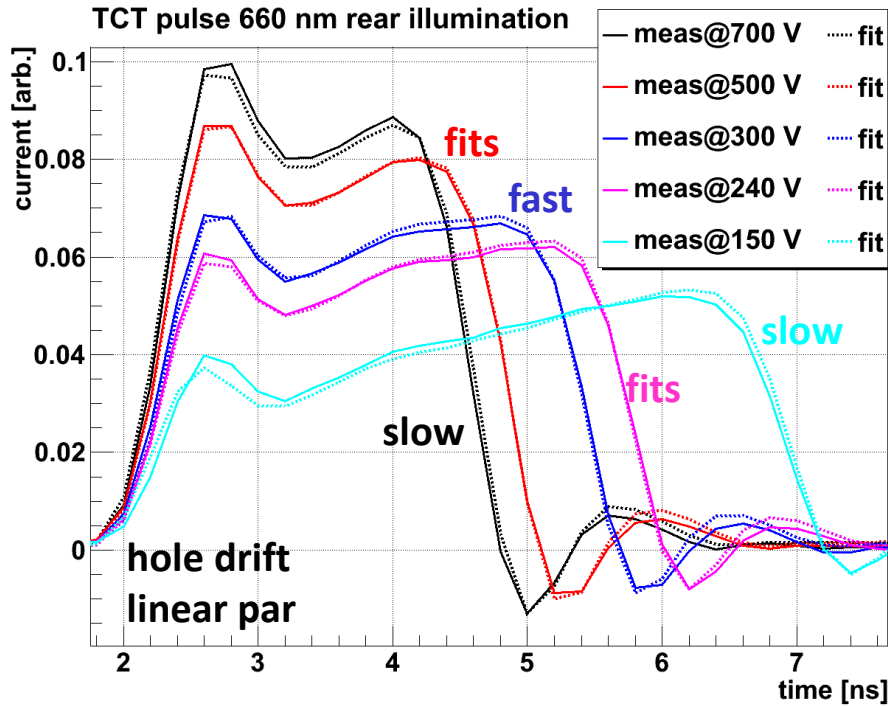


Fit with

$$v_d(E) = E \cdot \mu(E) = E \cdot \min\left(\mu_0, \frac{\mu_0}{1 + \mu_0/v_s \cdot (E - E_0)}\right)$$

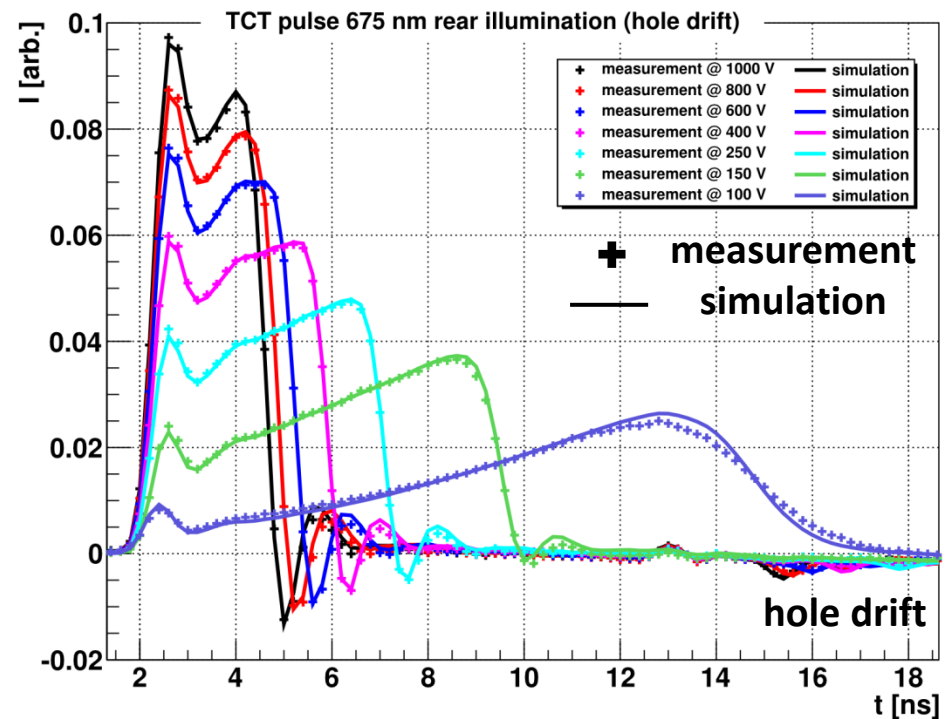
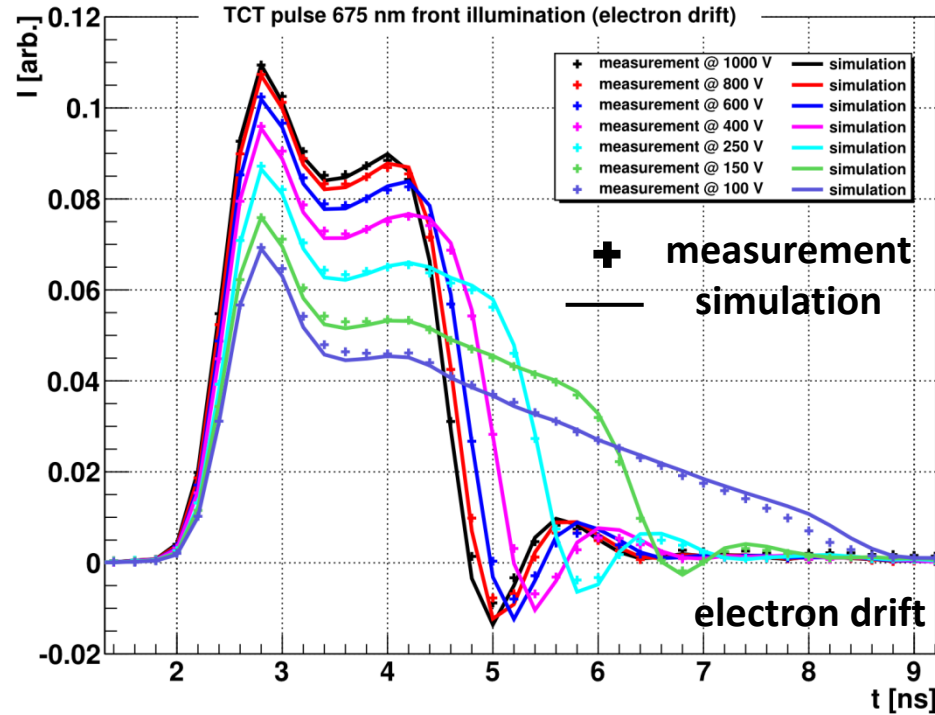


# Mobility model: holes linear @ -40C



- Holes
  - Linear par. leads to wrong drift times
  - 2<sup>nd</sup> degree polynomial

$$\frac{1}{\mu_h(E)} = \max\left(\frac{1}{\mu_0^h}, \frac{1}{\mu_0^h} + b \cdot (E - E_0) + c \cdot (E - E_0)^2\right)$$

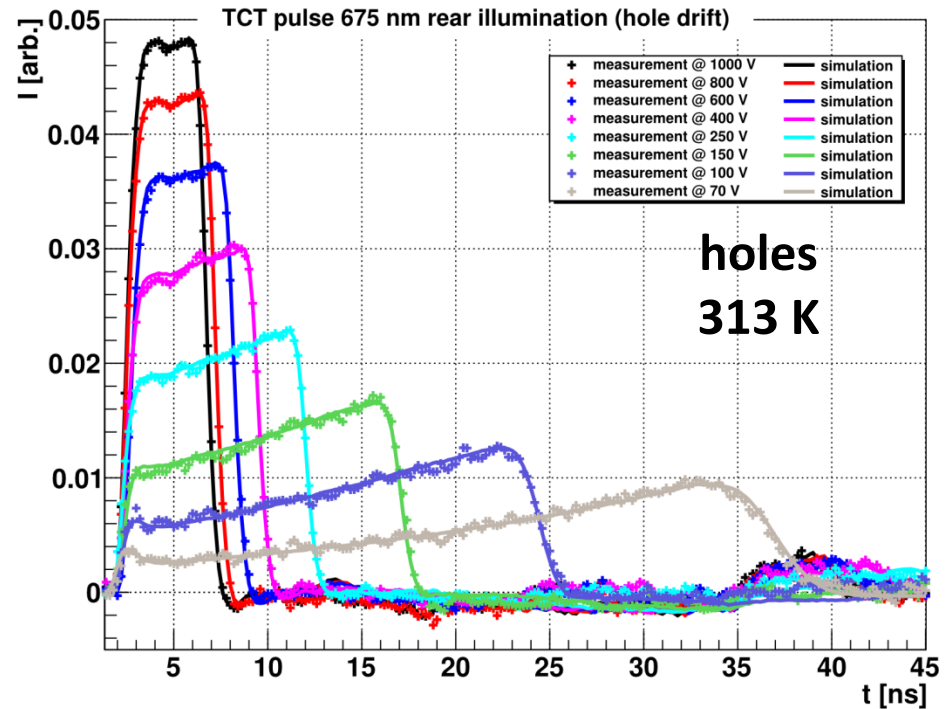
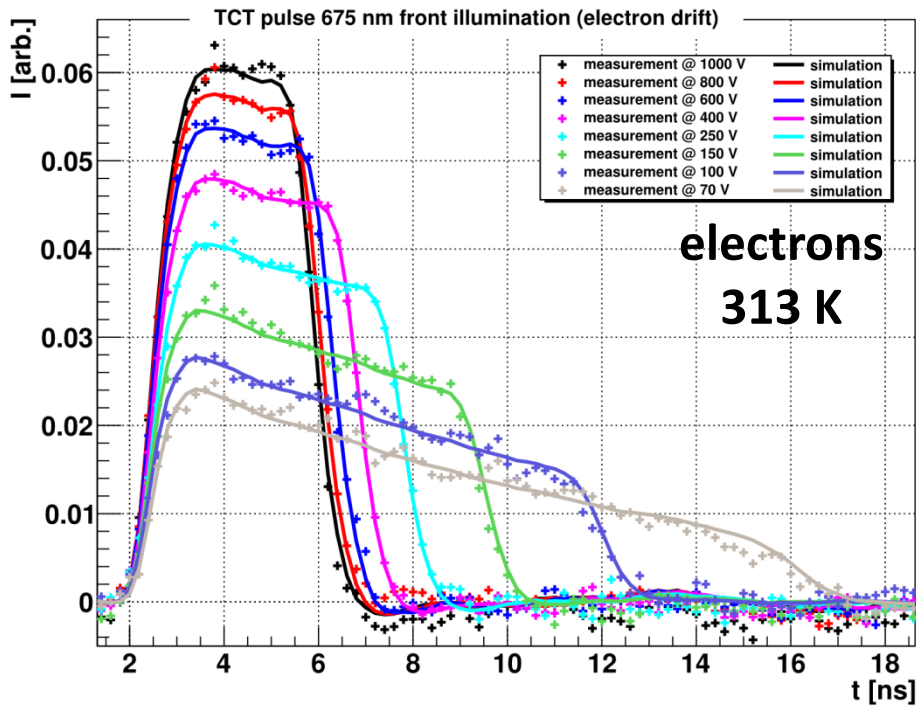


- Electrons 
$$\frac{1}{\mu_e(E)} = \frac{1}{\mu_0^e} + \frac{1}{v_s^e} \cdot E$$

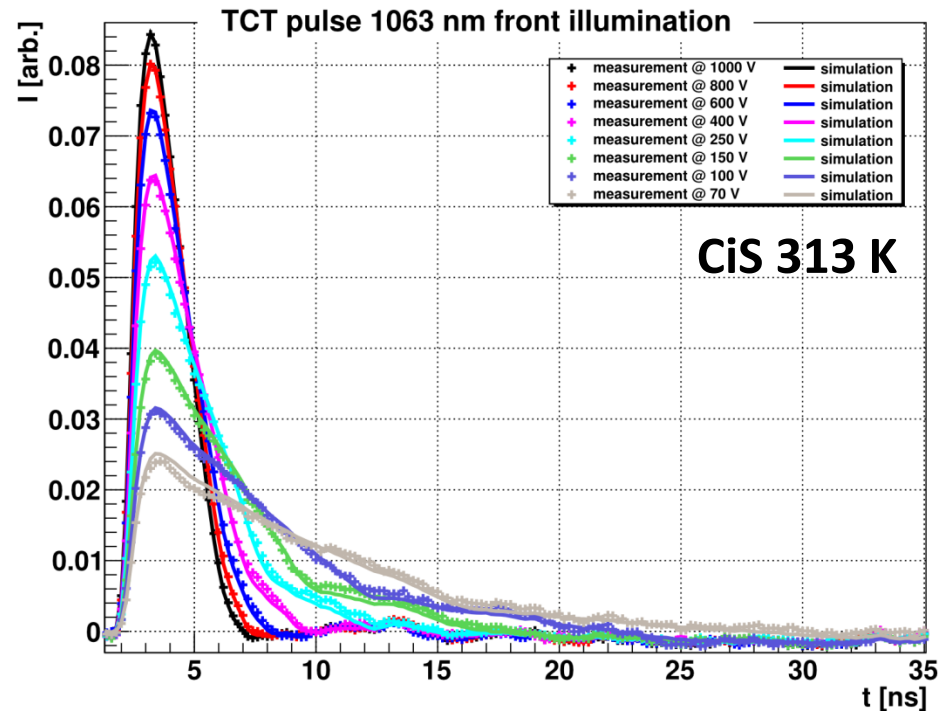
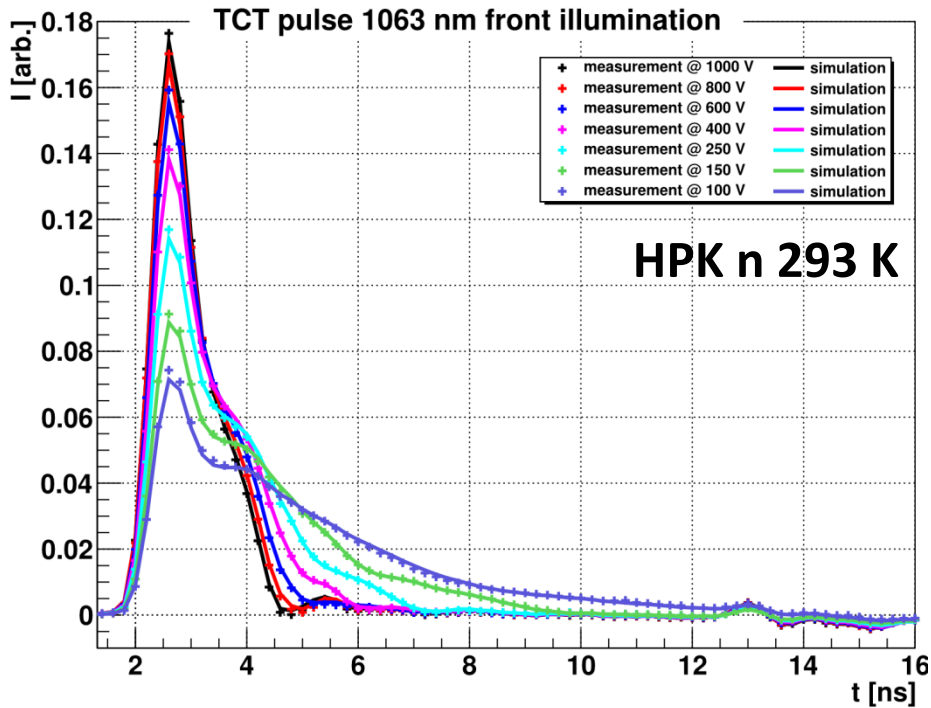
- Holes  $\rightarrow$  2<sup>nd</sup> degree polynomial

$$\frac{1}{\mu_h(E)} = \max\left(\frac{1}{\mu_0^h}, \frac{1}{\mu_0^h} + b \cdot (E - E_0) + c \cdot (E - E_0)^2\right)$$

# Backup CiS sensor

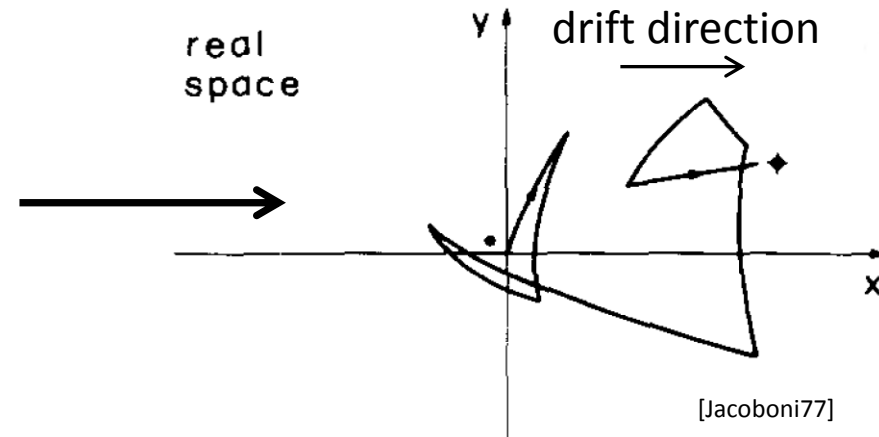


# Backup infrared



## Low electric field $E < E_0$

- Random thermal motion ( $v_{th} \approx 10^7$  cm/s) superimposed with drift in electric field

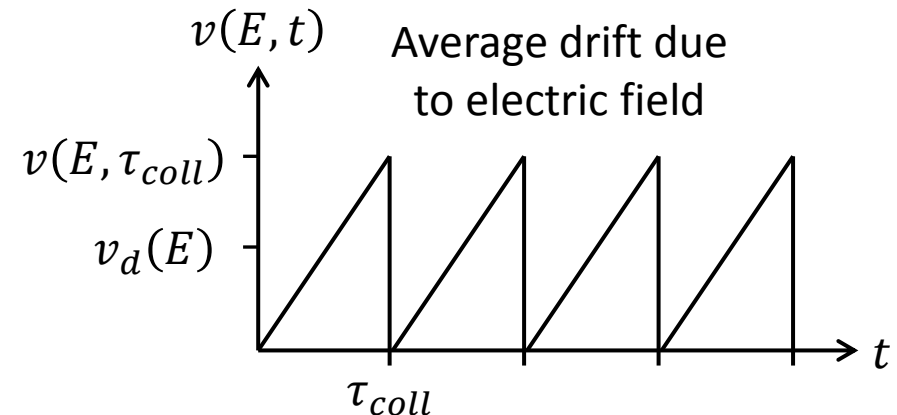


- Mean free time between lattice scattering

$$\tau_{coll} \propto v_{th} \gg v_d(E)$$

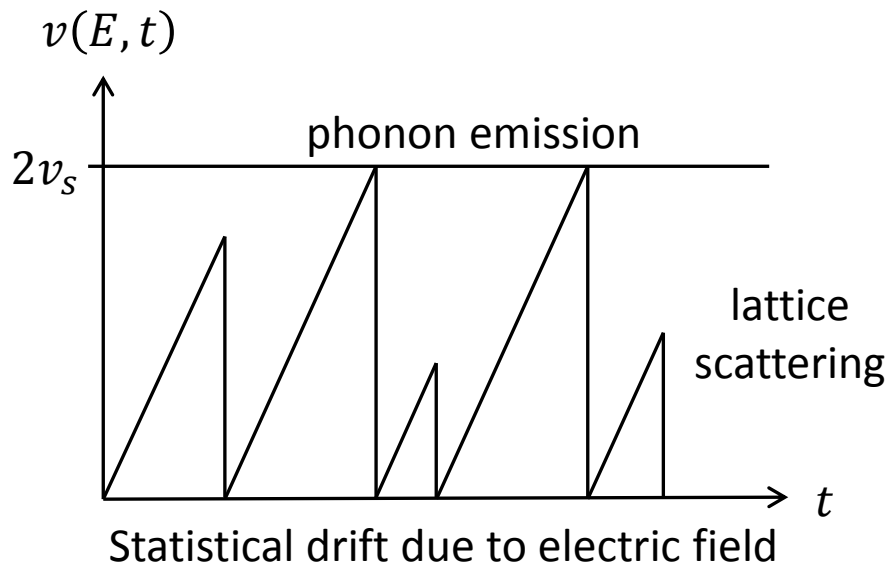
- Mean drift velocity

$$v_d(E) = \frac{1}{2} v(E, \tau_{coll}) = \frac{qE}{2m^*} \tau_{coll} = \mu_0 E$$



## High electric field $E \geq E_0$

- Energy sufficient for optical phonon emission
- Saturation velocity  $v_s \propto \sqrt{\hbar\omega_{phonon}}$

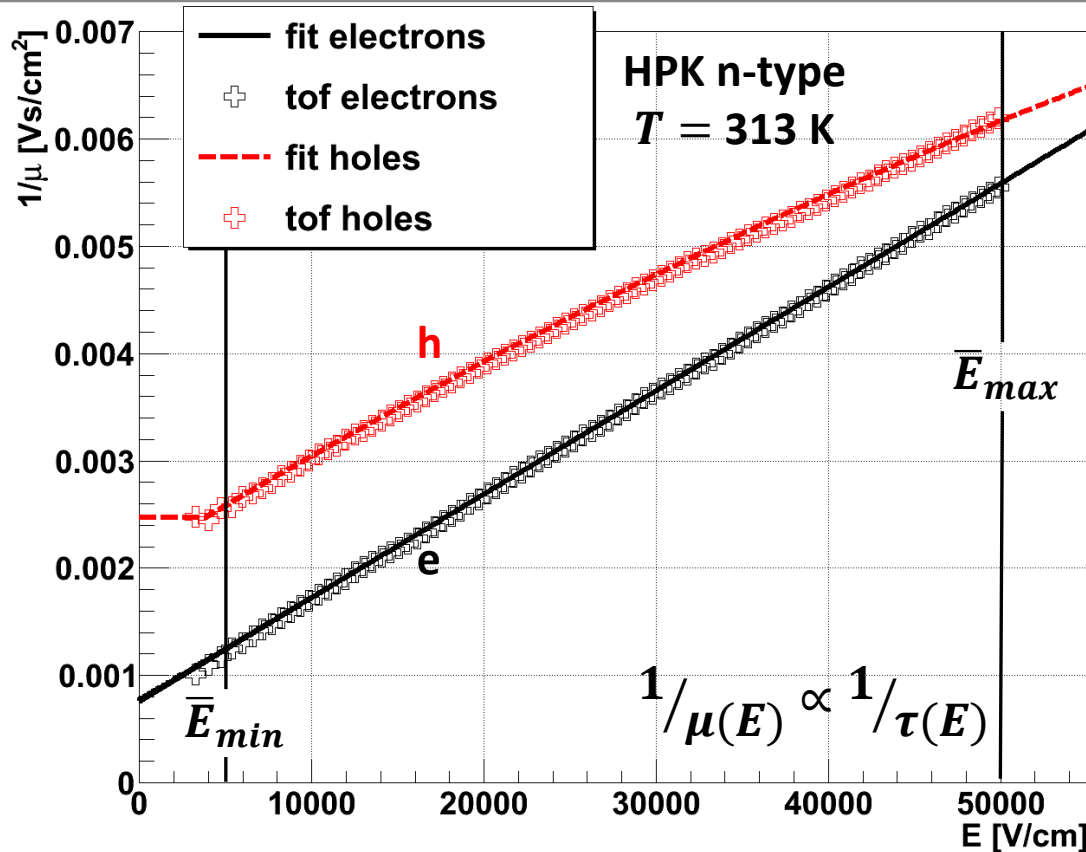


$$v_d(E) = \frac{qE}{2m^*} \tau(E)$$

$$\frac{1}{\tau(E)} = \frac{1}{\tau_{coll}} + \frac{1}{\tau_e(E)}$$

$\uparrow$                        $\uparrow$   
 lattice                      phonon  
 scattering                  emission

# Our results



**T dependence**

$$par_i(T) = par_i^{RT} \cdot \left( \frac{T}{300 \text{ K}} \right)^{\alpha_i}$$

**Global fit results ( $\sigma_{v_d} = \pm 2.5 \%$ )**

		$par_i^{RT}$	$\alpha_i$
Electrons	$\mu_0^e$	1430 cm <sup>2</sup> /Vs	-1.99
	$v_s^e$	$1.05 \cdot 10^7$ cm/s	-0.302
Holes	$\mu_0^h$	457 cm <sup>2</sup> /Vs	-2.80
	$b$	$9.57 \cdot 10^{-8}$ s/cm	-0.155
	$c$	$3.24 \cdot 10^{-13}$ s/V	—
	$E_0$	2970 V/cm	5.63

- **Electrons**  $1/\mu_e(E) = 1/\mu_0^e + 1/v_s^e \cdot E$

- **Holes**  $1/\mu_h(E) = \max \left( 1/\mu_0^h, 1/\mu_0^h + b \cdot (E - E_0) + c \cdot (E - E_0)^2 \right)$